| Item | Quantity | Reference | Value | Manufacturer | Manufacturer Part Number | Distributor | Distributor Part Number | Description | Pcb Footprint |
|------|----------|--|----------------|--|--------------------------|-------------|-------------------------|----------------------------------|----------------------|
| | 1 | 3 C33,C35,C38 | 100pF | Murata | GRM1555C1H101JA01D | Digikey | 490-5922-2-ND | CAP CER 100PF 50V 5% NP0 0402 | CC0402 |
| | 2 | 4 C34,C36,C42,C44 | 1pF | Murata | GRM1555C1H1R0CA01D | Digikey | 490-3199-2-ND | CAP CER 1PF 50V NPO 0402 | CC0402 |
| | 3 | 1 C37 | 10pF | Murata | GRM1555C1H100JA01D | Digikey | 490-5921-2-ND | CAP CER 10PF 50V 5% NP0 0402 | CC0402 |
| | 4 | 2 C39,C40 | 33pF | Murata | GRM1555C1E330JA01D | Digikey | 490-6177-2-ND | CAP CER 33PF 25V 5% NP0 0402 | CC0402 |
| | 5 | 2 C45,C46 | 1uF | Murata | GRM155R61A105KE15D | Digikey | 490-3890-2-ND | CAP CER 1UF 10V 10% X5R 0402 | CC0402 |
| | 6 | 2 C47,C48 | 0.1uF | Taiyo Yuden | LMK105BJ104KV-F | Digikey | 587-1227-2-ND | CAP CER 0.1UF 10V 10% X5R 0402 | CC0402 |
| | 7 | 4 E1,E2,E4,E6 | 2.45GHz Ant | Taiyo Yuden | AH316M245001-T | Digikey | | ANT BLUETOOTH W-LAN ZIGBEE WIMAX | ANT_AH316M |
| | 8 | 2 J1,J2 | CONN_RCPT_10x2 | Samtec Inc | SSQ-110-03-T-D | Digikey | | CONN RCPT .100" 20POS DUAL TIN | HDR_THVT_2X10_100_F |
| ! | 9 | 3 J17,J18,J19 | CONN_U.FL | Emerson Network Power Connectivity Johnson | 128-0711-201 | Digikey | | CONN UMC RCPT STR 50 OHM SMD | EMERSON_128-0711-201 |
| 10 | 0 | 3 L7,L12,L13 | NC | No need to order | | | | | indc_0402cs |
| 1 | 1 | 4 L10,L11,L15,L17 | 3.6nH | Murata | LQP15MN3N6B02D | Digikey | 490-6756-2-ND | INDUCTOR 3.6NH 0.1NH 0402 | indc_0402cs |
| 1 | 2 | R44,R46,R50,R76,R83,R85,R89,R91,R94 ,R95,R96,R97,R98,R99 | NC | No need to order | | | | | rc0402 |
| 1 | 3 | 15 R45,R47,R62,R64,R73,R74,R79,R80,R81 ,R82,R86,R88,R90,R92,R93 | 0E | Panasonic Electronic Components | ERJ-2GE0R00X | Digikey | | RES 0.0 OHM 1/10W JUMP 0402 SMD | rc0402 |
| 1- | 4 | 2 R59,R60 | 0E | Panasonic | ERJ-3GEYOROOV | Digikey | P0.0GTR-ND | RES 0.0 OHM 1/10W JUMP 0603 SMD | RC0603 |
| 1. | 5 | 3 TP9,TP10,TP11 | TP THRU | FCI | 68001-101HLF | Digikey | 609-3467-ND | BERGSTIK II .100" SR STRAIGHT | HDR_THVT_1X1_100_M |
| 1 | 6 | 1 U1 | SWITCH | SKYWORKS | SKY13351-378LF | | | 20 MHz-6.0 GHz GaAs SPDT Switch | SW_SKY13351-378LF |
| 1 | 7 | 1 U4 | SN74AVCH2T45 | TI | SN74AVCH2T45DCUR | Digikey | 296-19109-2-ND | IC BUS TRANSCVR TRI-ST 2B US8 | |
| 1 | 8 | 2 U6,U7 | INVERTER | DIODES INC | 74AHC1GU04W5-7 | Digikey | 74AHC1GU04W5-7DITR-ND | | SOT23-5 |

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